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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	ARM® Cortex®-M4
Core Size	32-Bit Single-Core
Speed	72MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I <sup>2</sup> C, IrDA, LINbus, MMC/SD/SDIO, QSPI, SmartCard, SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, DMA, LCD, POR, PWM, WDT
Number of I/O	87
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.8V
Data Converters	A/D 16x12b SAR; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	112-LFBGA
Supplier Device Package	112-BGA (10x10)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/silicon-labs/efm32gg11b420f2048gl112-b">https://www.e-xfl.com/product-detail/silicon-labs/efm32gg11b420f2048gl112-b</a>

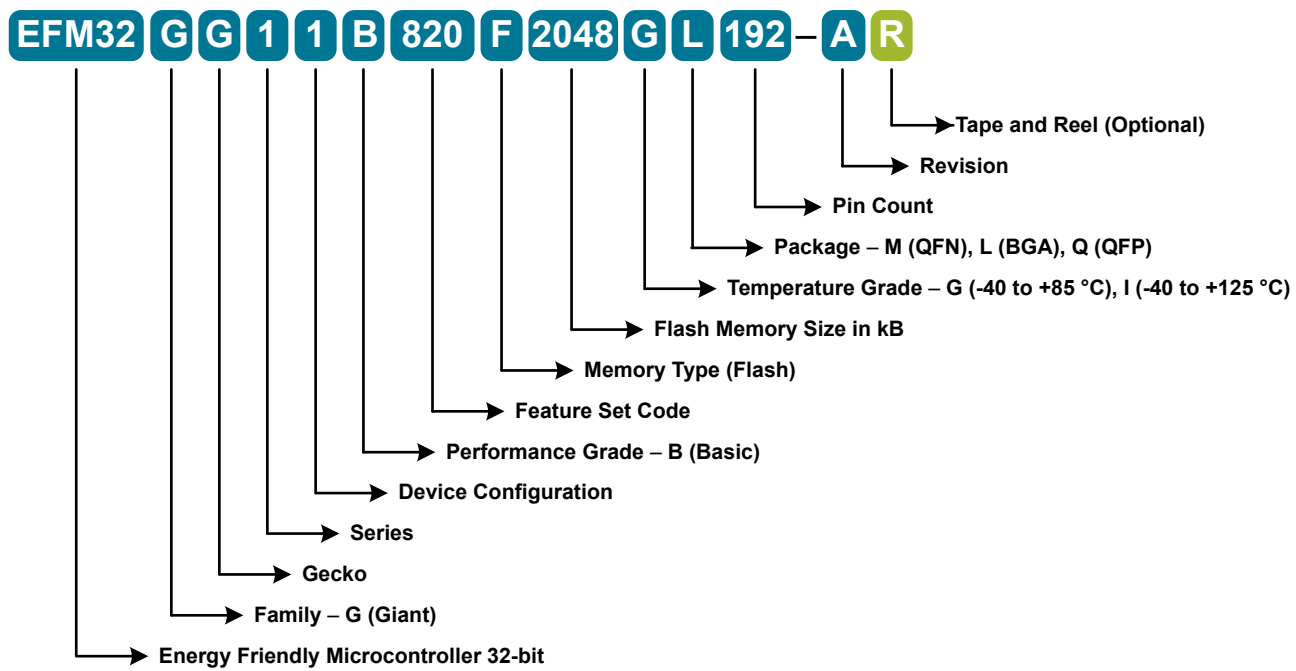


Figure 2.1. Ordering Code Key

### 3.4.2 Internal and External Oscillators

The EFM32GG11 supports two crystal oscillators and fully integrates five RC oscillators, listed below.

- A high frequency crystal oscillator (HFXO) with integrated load capacitors, tunable in small steps, provides a precise timing reference for the MCU. Crystal frequencies in the range from 4 to 50 MHz are supported. An external clock source such as a TCXO can also be applied to the HFXO input for improved accuracy over temperature.
- A 32.768 kHz crystal oscillator (LFXO) provides an accurate timing reference for low energy modes.
- An integrated high frequency RC oscillator (HFRCO) is available for the MCU system. The HFRCO employs fast startup at minimal energy consumption combined with a wide frequency range. When crystal accuracy is not required, it can be operated in free-running mode at a number of factory-calibrated frequencies. A digital phase-locked loop (DPLL) feature allows the HFRCO to achieve higher accuracy and stability by referencing other available clock sources such as LFXO and HFXO.
- An integrated auxiliary high frequency RC oscillator (AUXHFRCO) is available for timing the general-purpose ADC and the Serial Wire Viewer port with a wide frequency range.
- An integrated auxiliary high frequency RC oscillator (USHFRCO) is available for timing the USB, SDIO and QSPI peripherals. The USHFRCO can be synchronized to the host's USB clock to allow the USB to operate in device mode without the additional cost of an external crystal.
- An integrated low frequency 32.768 kHz RC oscillator (LFRCO) can be used as a timing reference in low energy modes, when crystal accuracy is not required.
- An integrated ultra-low frequency 1 kHz RC oscillator (ULFRCO) is available to provide a timing reference at the lowest energy consumption in low energy modes.

## 3.5 Counters/Timers and PWM

### 3.5.1 Timer/Counter (TIMER)

TIMER peripherals keep track of timing, count events, generate PWM outputs and trigger timed actions in other peripherals through the PRS system. The core of each TIMER is a 16-bit counter with up to 4 compare/capture channels. Each channel is configurable in one of three modes. In capture mode, the counter state is stored in a buffer at a selected input event. In compare mode, the channel output reflects the comparison of the counter to a programmed threshold value. In PWM mode, the TIMER supports generation of pulse-width modulation (PWM) outputs of arbitrary waveforms defined by the sequence of values written to the compare registers, with optional dead-time insertion available in timer unit TIMER\_0 only.

### 3.5.2 Wide Timer/Counter (WTIMER)

WTIMER peripherals function just as TIMER peripherals, but are 32 bits wide. They keep track of timing, count events, generate PWM outputs and trigger timed actions in other peripherals through the PRS system. The core of each WTIMER is a 32-bit counter with up to 4 compare/capture channels. Each channel is configurable in one of three modes. In capture mode, the counter state is stored in a buffer at a selected input event. In compare mode, the channel output reflects the comparison of the counter to a programmed threshold value. In PWM mode, the WTIMER supports generation of pulse-width modulation (PWM) outputs of arbitrary waveforms defined by the sequence of values written to the compare registers, with optional dead-time insertion available in timer unit WTIMER\_0 only.

### 3.5.3 Real Time Counter and Calendar (RTCC)

The Real Time Counter and Calendar (RTCC) is a 32-bit counter providing timekeeping in all energy modes. The RTCC includes a Binary Coded Decimal (BCD) calendar mode for easy time and date keeping. The RTCC can be clocked by any of the on-board oscillators with the exception of the AUXHFRCO, and it is capable of providing system wake-up at user defined instances. The RTCC includes 128 bytes of general purpose data retention, allowing easy and convenient data storage in all energy modes down to EM4H.

### 3.5.4 Low Energy Timer (LETIMER)

The unique LETIMER is a 16-bit timer that is available in energy mode EM2 Deep Sleep in addition to EM1 Sleep and EM0 Active. This allows it to be used for timing and output generation when most of the device is powered down, allowing simple tasks to be performed while the power consumption of the system is kept at an absolute minimum. The LETIMER can be used to output a variety of waveforms with minimal software intervention. The LETIMER is connected to the Real Time Counter and Calendar (RTCC), and can be configured to start counting on compare matches from the RTCC.

### 3.5.5 Ultra Low Power Wake-up Timer (CRYOTIMER)

The CRYOTIMER is a 32-bit counter that is capable of running in all energy modes. It can be clocked by either the 32.768 kHz crystal oscillator (LFXO), the 32.768 kHz RC oscillator (LFRCO), or the 1 kHz RC oscillator (ULFRCO). It can provide periodic Wakeup events and PRS signals which can be used to wake up peripherals from any energy mode. The CRYOTIMER provides a wide range of interrupt periods, facilitating flexible ultra-low energy operation.

#### 4.1.4 DC-DC Converter

Test conditions: L\_DCDC=4.7  $\mu$ H (Murata LQH3NPN4R7MM0L), C\_DCDC=4.7  $\mu$ F (Samsung CL10B475KQ8NQNC), V\_DCDC\_I=3.3 V, V\_DCDC\_O=1.8 V, I\_DCDC\_LOAD=50 mA, Heavy Drive configuration, F\_DCDC\_LN=7 MHz, unless otherwise indicated.

**Table 4.4. DC-DC Converter**

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Input voltage range	V <sub>DCDC_I</sub>	Bypass mode, I <sub>DCDC_LOAD</sub> = 50 mA	1.8	—	V <sub>VREGVDD_MAX</sub>	V
		Low noise (LN) mode, 1.8 V output, I <sub>DCDC_LOAD</sub> = 100 mA, or Low power (LP) mode, 1.8 V output, I <sub>DCDC_LOAD</sub> = 10 mA	2.4	—	V <sub>VREGVDD_MAX</sub>	V
		Low noise (LN) mode, 1.8 V output, I <sub>DCDC_LOAD</sub> = 200 mA	2.6	—	V <sub>VREGVDD_MAX</sub>	V
Output voltage programmable range <sup>1</sup>	V <sub>DCDC_O</sub>		1.8	—	V <sub>VREGVDD</sub>	V
Regulation DC accuracy	ACC <sub>DC</sub>	Low Noise (LN) mode, 1.8 V target output	TBD	—	TBD	V
Regulation window <sup>4</sup>	WIN <sub>REG</sub>	Low Power (LP) mode, LPCMPBIASEMxx <sup>3</sup> = 0, 1.8 V target output, I <sub>DCDC_LOAD</sub> ≤ 75 $\mu$ A	TBD	—	TBD	V
		Low Power (LP) mode, LPCMPBIASEMxx <sup>3</sup> = 3, 1.8 V target output, I <sub>DCDC_LOAD</sub> ≤ 10 mA	TBD	—	TBD	V
Steady-state output ripple	V <sub>R</sub>		—	3	—	mVpp
Output voltage under/overshoot	V <sub>OV</sub>	CCM Mode (LNFORCECCM <sup>3</sup> = 1), Load changes between 0 mA and 100 mA	—	25	TBD	mV
		DCM Mode (LNFORCECCM <sup>3</sup> = 0), Load changes between 0 mA and 10 mA	—	45	TBD	mV
		Overshoot during LP to LN CCM/DCM mode transitions compared to DC level in LN mode	—	200	—	mV
		Undershoot during BYP/LP to LN CCM (LNFORCECCM <sup>3</sup> = 1) mode transitions compared to DC level in LN mode	—	40	—	mV
		Undershoot during BYP/LP to LN DCM (LNFORCECCM <sup>3</sup> = 0) mode transitions compared to DC level in LN mode	—	100	—	mV
DC line regulation	V <sub>REG</sub>	Input changes between V <sub>VREGVDD_MAX</sub> and 2.4 V	—	0.1	—	%
DC load regulation	I <sub>REG</sub>	Load changes between 0 mA and 100 mA in CCM mode	—	0.1	—	%

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Current consumption in EM4H mode, with voltage scaling enabled	I <sub>EM4H_VS</sub>	128 byte RAM retention, RTCC running from LFXO	—	0.94	—	μA
		128 byte RAM retention, CRYO-TIMER running from ULFRCO	—	0.62	—	μA
		128 byte RAM retention, no RTCC	—	0.62	—	μA
Current consumption in EM4S mode	I <sub>EM4S</sub>	No RAM retention, no RTCC	—	0.13	—	μA
Current consumption of peripheral power domain 1, with voltage scaling enabled, DCDC in LP mode <sup>3</sup>	I <sub>PD1_VS</sub>	Additional current consumption in EM2/3 when any peripherals on power domain 1 are enabled <sup>4</sup>	—	0.68	—	μA
Current consumption of peripheral power domain 2, with voltage scaling enabled, DCDC in LP mode <sup>3</sup>	I <sub>PD2_VS</sub>	Additional current consumption in EM2/3 when any peripherals on power domain 2 are enabled <sup>4</sup>	—	0.28	—	μA

**Note:**

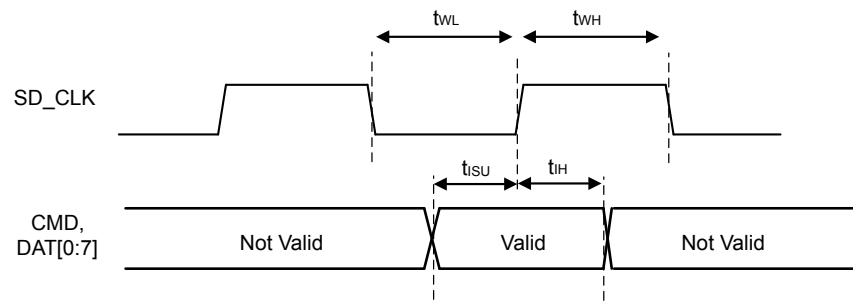
1. DCDC Low Noise CCM Mode = Light Drive (PFETCNT=NFETCNT=3), F=6.4 MHz (RCOBAND=4), ANASW=DVDD.
2. DCDC Low Noise DCM Mode = Light Drive (PFETCNT=NFETCNT=3), F=3.0 MHz (RCOBAND=0), ANASW=DVDD.
3. DCDC Low Power Mode = Medium Drive (PFETCNT=NFETCNT=7), LPOSCDIV=1, LPCMPBIASEM234H=0, LPCLIMILIMSEL=1, ANASW=DVDD.
4. Extra current consumed by power domain. Does not include current associated with the enabled peripherals. See [3.2.4 EM2 and EM3 Power Domains](#) for a list of the peripherals in each power domain.
5. CMU\_LFRCCOCTRL\_ENVREF = 1, CMU\_LFRCCOCTRL\_VREFUPDATE = 1

## SDIO HS Mode Timing

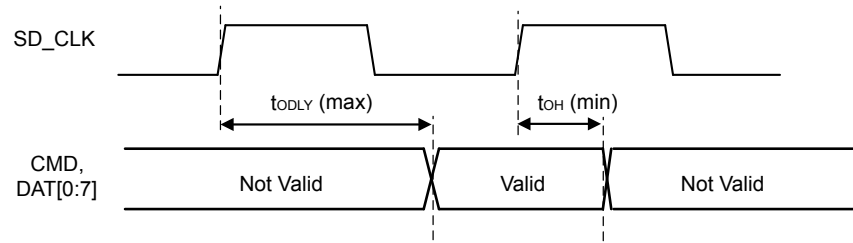
Timing is specified for route location 0 at 3.0 V IOVDD with voltage scaling disabled. Slew rate for SD\_CLK set to 7, all other GPIO set to 6, DRIVESTRENGTH = STRONG for all pins. SDIO\_CTRL\_TXDLYMUXSEL = 0. Loading between 5 and 10 pF on all pins or between 10 and 20 pF on all pins.

**Table 4.47. SDIO HS Mode Timing (Location 0)**

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Clock frequency during data transfer	F <sub>SD_CLK</sub>	Using HFRCO, AUXHFRCO, or USHFRCO	—	—	45	MHz
		Using HFXO	—	—	TBD	MHz
Clock low time	t <sub>WL</sub>	Using HFRCO, AUXHFRCO, or USHFRCO	10.0	—	—	ns
		Using HFXO	TBD	—	—	ns
Clock high time	t <sub>WH</sub>	Using HFRCO, AUXHFRCO, or USHFRCO	10.0	—	—	ns
		Using HFXO	TBD	—	—	ns
Clock rise time	t <sub>R</sub>		1.69	3.23	—	ns
Clock fall time	t <sub>F</sub>		1.42	2.79	—	ns
Input setup time, CMD, DAT[0:3] valid to SD_CLK	t <sub>ISU</sub>		6	—	—	ns
Input hold time, SD_CLK to CMD, DAT[0:3] change	t <sub>IH</sub>		2.5	—	—	ns
Output delay time, SD_CLK to CMD, DAT[0:3] valid	t <sub>ODLY</sub>		0	—	13	ns
Output hold time, SD_CLK to CMD, DAT[0:3] change	t <sub>OH</sub>		2	—	—	ns



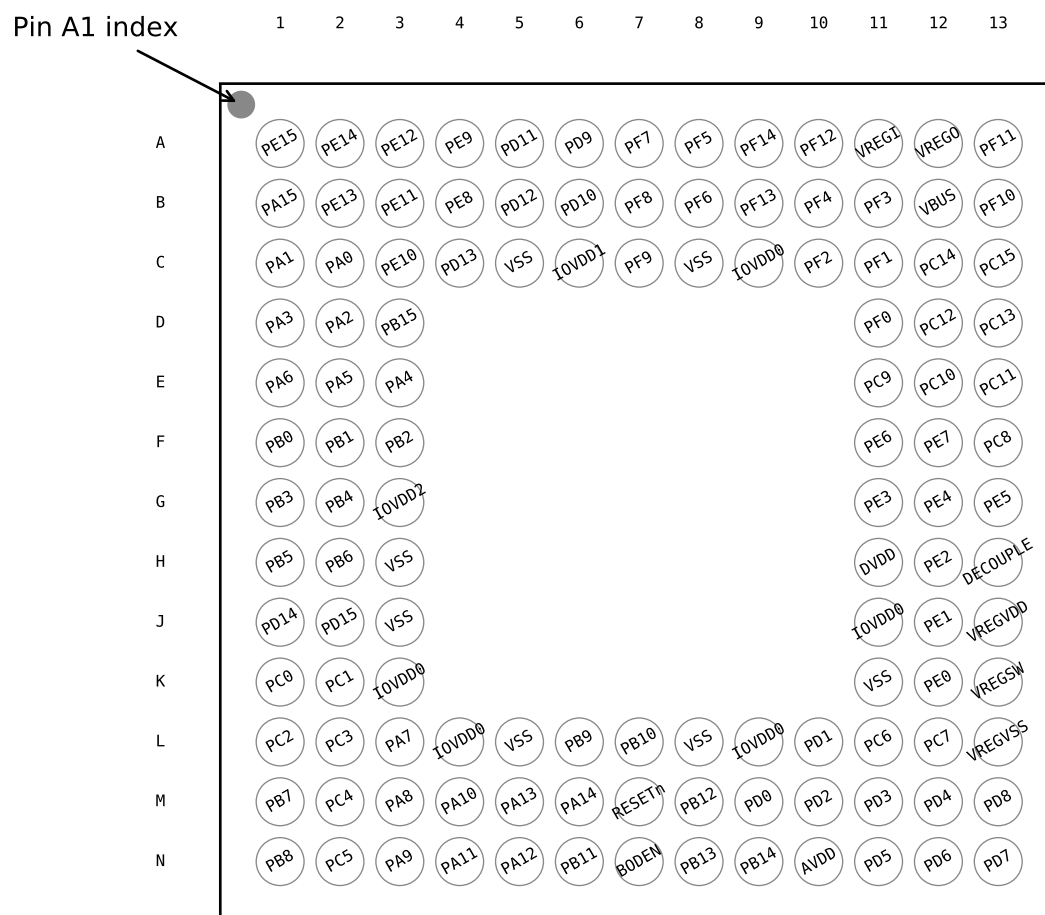
Input Timing



Output Timing

**Figure 4.14. SDIO HS Mode Timing**

### 5.3 EFM32GG11B8xx in BGA120 Device Pinout



**Figure 5.3. EFM32GG11B8xx in BGA120 Device Pinout**

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see [5.20 GPIO Functionality Table](#) or [5.21 Alternate Functionality Overview](#).

**Table 5.3. EFM32GG11B8xx in BGA120 Device Pinout**

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PE15	A1	GPIO	PE14	A2	GPIO
PE12	A3	GPIO	PE9	A4	GPIO
PD11	A5	GPIO	PD9	A6	GPIO
PF7	A7	GPIO	PF5	A8	GPIO
PF14	A9	GPIO (5V)	PF12	A10	GPIO
VREGI	A11	Input to 5 V regulator.	VREGO	A12	Decoupling for 5 V regulator and regulator output. Power for USB PHY in USB-enabled OPNs



Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PE8	B4	GPIO	PD11	B5	GPIO
PF8	B6	GPIO	PF6	B7	GPIO
PF3	B8	GPIO	PE5	B9	GPIO
PC12	B10	GPIO (5V)	PC13	B11	GPIO (5V)
PA1	C1	GPIO	PA0	C2	GPIO
PE10	C3	GPIO	PD13	C4	GPIO (5V)
PD12	C5	GPIO	PF9	C6	GPIO
VSS	C7 D4 F9 G3 G9 H6 K4 K7 K10 L7	Ground	PF2	C8	GPIO
PE6	C9	GPIO	PC10	C10	GPIO (5V)
PC11	C11	GPIO (5V)	PA3	D1	GPIO
PA2	D2	GPIO	PB15	D3	GPIO (5V)
IOVDD1	D5	Digital IO power supply 1.	PD9	D6	GPIO
IOVDD0	D7 G8 H7 L4	Digital IO power supply 0.	PF1	D8	GPIO (5V)
PE7	D9	GPIO	PC8	D10	GPIO (5V)
PC9	D11	GPIO (5V)	PA6	E1	GPIO
PA5	E2	GPIO	PA4	E3	GPIO
PB0	E4	GPIO	PF0	E8	GPIO (5V)
PE0	E9	GPIO (5V)	PE1	E10	GPIO (5V)
PE3	E11	GPIO	PB1	F1	GPIO
PB2	F2	GPIO	PB3	F3	GPIO
PB4	F4	GPIO	DVDD	F8	Digital power supply.
PE2	F10	GPIO	DECOUPLE	F11	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.
PB5	G1	GPIO	PB6	G2	GPIO
IOVDD2	G4	Digital IO power supply 2.	PC6	G10	GPIO
PC7	G11	GPIO	PC0	H1	GPIO (5V)
PC2	H2	GPIO (5V)	PD14	H3	GPIO (5V)
PA7	H4	GPIO	PA8	H5	GPIO
PD8	H8	GPIO	PD5	H9	GPIO
PD6	H10	GPIO	PD7	H11	GPIO

GPIO Name	Pin Alternate Functionality / Description				
	Analog	EBI	Timers	Communication	Other
PF7	BUSCY BUSDX LCD_SEG25	EBI_BL1 #0 EBI_BL1 #4 EBI_BL1 #5 EBI_DCLK #1	TIM0_CC1 #1 TIM4_CC1 #4	ETH_RMIITXD0 #1 US2_RX #4 QSPI0_CS0 #0 ETH_MIIRXER #2 US1_RX #3 U0_RX #0	PRS_CH23 #2
PF6	BUSDY BUSCX LCD_SEG24	EBI_BL0 #0 EBI_BL0 #4 EBI_BL0 #5 EBI_CSTFT #1	TIM0_CC0 #1 TIM4_CC0 #4 WTIM3_CC2 #5	ETH_RMIITXD1 #1 US2_TX #4 QSPI0_SCLK #0 US1_TX #3 U0_TX #0	PRS_CH22 #2
PI11				US4_RTS #3	
PI8		EBI_A13 #2	TIM1_CC2 #7 TIM4_CC0 #3	US4_CLK #3	
PF5	BUSCY BUSDX LCD_SEG3	EBI_REn #0 EBI_REn #5 EBI_A27 #1	TIM0_CDTI2 #2 TIM1_CC3 #6 TIM4_CC0 #2	US2_CS #5 I2C2_SCL #0 USB_VBUSEN	PRS_CH2 #1 DBG_TDI
PF13	BUSCY BUSDX		TIM1_CC0 #6 TIM4_CC0 #1 TIM5_CC1 #7 WTIM3_CC0 #7	US5_CLK #2 I2C2_SDA #4	
PF3	BUSCY BUSDX LCD_SEG1	EBI_ALE #0	TIM4_CC0 #0 TIM0_CDTI0 #2 TIM1_CC1 #5	CAN1_TX #1 US1_CTS #2 I2C2_SCL #5	CMU_CLK1 #4 PRS_CH0 #1 ETM_TD3 #1
PF2	BUSDY BUSCX LCD_SEG0	EBI_ARDY #0 EBI_A26 #1	TIM0_CC2 #4 TIM1_CC0 #5 TIM2_CC0 #3	US2_CLK #5 CAN0_TX #1 US1_TX #5 U0_RX #5 LEU0_TX #4 I2C1_SCL #4	CMU_CLK0 #4 PRS_CH0 #3 ACMP1_O #0 DBG_TDO DBG_SWO #0 GPIO_EM4WU4
PF1	BUSCY BUSDX	EBI_A25 #1	TIM0_CC1 #4 WTIM0_CC2 #4 LE- TIM0_OUT1 #2	US2_RX #5 CAN1_RX #1 US1_CS #2 U0_TX #5 LEU0_RX #3 I2C0_SCL #5	PRS_CH4 #2 DBG_SWDIOTMS GPIO_EM4WU3 BOOT_RX
PA1	BUSAY USBX LCD_SEG14	EBI_AD10 #0 EBI_DCLK #3	TIM0_CC0 #7 TIM0_CC1 #0 TIM3_CC1 #4 PCNT0_S1IN #4	ETH_RMIIRXD1 #0 ETH_MIITXD3 #0 SDIO_DAT1 #1 US3_RX #0 QSPI0_CS1 #1 I2C0_SCL #0	CMU_CLK1 #0 PRS_CH1 #0
PD12	LCD_SEG31	EBI_CS3 #0	TIM4_CC1 #6	ETH_RMIIRXER #1 SDIO_DAT4 #0 QSPI0_DQ3 #0 ETH_MIIRXCLK #2 US4_CS #1	
PD14		EBI_NANDWEn #1	TIM2_CDTI1 #1 TIM3_CC2 #6 WTIM0_CC2 #1	ETH_MDC #1 CAN0_RX #5 US4_RTS #1 US5_CS #1 I2C0_SDA #3	

GPIO Name	Pin Alternate Functionality / Description				
	Analog	EBI	Timers	Communication	Other
PH14	BUSACMP3Y BU-SACMP3X	EBI_A26 #2	TIM5_CC1 #2 WTIM1_CC2 #7 PCNT2_S0IN #7	US5_CTS #3 U1_RTS #5 I2C1_SCL #6	
PH15	BUSACMP3Y BU-SACMP3X	EBI_A27 #2	TIM5_CC2 #2 WTIM1_CC3 #7 PCNT2_S1IN #6	US5_RTS #3	
PD2	BUSADC0Y BU-SADC0X	EBI_A06 #1 EBI_A15 #3 EBI_A27 #0	TIM0_CC1 #2 TIM6_CC1 #6 WTIM1_CC0 #1	US1_CLK #1 LEU1_TX #2	DBG_SWO #3
PD7	BUSADC0Y BU-SADC0X ADC0_EXTN ADC1_EXTN OPA1_N	EBI_A11 #1 EBI_A20 #3	TIM1_CC1 #4 WTIM1_CC1 #2 LE- TIM0_OUT1 #0 PCNT0_S1IN #3	US1_TX #2 US3_CLK #1 U0_TX #6 I2C0_SCL #1	CMU_CLK0 #2 LES_ALTEX1 ACMP1_O #2 ETM_TCLK #0
PB8	LFXTAL_N		TIM0_CDTI1 #4 TIM1_CC1 #3	US0_RX #4 US1_CS #0 US4_RX #0 U0_RTS #4	CMU_CLKI0 #2 PRS_CH23 #0
PC4	BUSACMP0Y BU-SACMP0X OPA0_P	EBI_AD11 #1 EBI_ALE #2 EBI_NANDREn #3 EBI_A26 #0	TIM0_CC0 #5 TIM0_CDTI2 #3 TIM2_CC2 #5 LE- TIM0_OUT0 #3 PCNT1_S0IN #3	SDIO_CD #1 US2_CLK #0 US4_CLK #0 U0_TX #4 U1_CTS #4 I2C1_SDA #0	LES_CH4 PRS_CH18 #2 GPIO_EM4WU6
PA7	BUSAY BUSBX LCD_SEG35	EBI_AD13 #1 EBI_A01 #3 EBI_CSTFT #0	TIM0_CC2 #5 LE- TIM1_OUT0 #0 PCNT1_S0IN #4	US2_TX #2 US4_CTS #0 US5_RX #1	PRS_CH7 #1
PA10	BUSBY BUSAX LCD_SEG38	EBI_CS0 #1 EBI_A04 #3 EBI_VSNC #0	TIM2_CC2 #0 TIM0_CC2 #6 WTIM2_CC1 #0	US2_CS #2	PRS_CH10 #0
PA12	BUSBY BUSAX	EBI_CS2 #1 EBI_REn #2 EBI_A00 #0 EBI_A06 #3	TIM2_CC0 #1 WTIM0_CDTI0 #2 WTIM2_CC0 #1 LE- TIM1_OUT0 #2 PCNT1_S0IN #5	CAN1_RX #5 US0_CLK #5 US2_RTS #2	CMU_CLK0 #5 PRS_CH12 #0 ACMP1_O #3
PA14	BUSBY BUSAX LCD_BEXT	EBI_REn #1 EBI_A02 #0 EBI_A08 #3	TIM2_CC2 #1 WTIM0_CDTI2 #2 WTIM2_CC2 #1 LE- TIM1_OUT1 #2	US1_TX #6 US2_RX #3 US3_RTS #2	PRS_CH14 #0 ACMP1_O #4
PB11	BUSAY BUSBX VDAC0_OUT0 / OPA0_OUT IDAC0_OUT	EBI_BL1 #2 EBI_A02 #1 EBI_A11 #3	TIM0_CDTI2 #4 TIM1_CC2 #3 WTIM2_CC2 #2 LE- TIM0_OUT0 #1 PCNT0_S1IN #7 PCNT1_S0IN #6	US0_CTS #5 US1_CLK #5 US2_CS #3 US5_CLK #0 U1_CTS #2 I2C1_SDA #1	CMU_CLK1 #5 CMU_CLKI0 #7 PRS_CH21 #2 ACMP0_O #3 GPIO_EM4WU7
PH1	BUSADC1Y BU-SADC1X	EBI_DTEN #2		US0_RTS #6 LEU1_RX #5	
PH4	BUSADC1Y BU-SADC1X	EBI_A16 #2	TIM6_CC2 #3 WTIM2_CC0 #6	US4_TX #4	
PH7	BUSADC1Y BU-SADC1X	EBI_A19 #2	TIM6_CDTI2 #3 WTIM2_CC0 #7	US4_CS #4	
PH10	BUSACMP3Y BU-SACMP3X	EBI_A22 #2	TIM6_CC2 #4 WTIM1_CC2 #6	US5_TX #3	

## 5.21 Alternate Functionality Overview

A wide selection of alternate functionality is available for multiplexing to various pins. The following table shows the name of the alternate functionality in the first column, followed by columns showing the possible LOCATION bitfield settings and the associated GPIO pin. Refer to [5.20 GPIO Functionality Table](#) for a list of functions available on each GPIO pin.

**Note:** Some functionality, such as analog interfaces, do not have alternate settings or a LOCATION bitfield. In these cases, the pinout is shown in the column corresponding to LOCATION 0.

**Table 5.21. Alternate Functionality Overview**

Alternate	LOCATION		Description
Functionality	0 - 3	4 - 7	
ACMP0_O	0: PE13 1: PE2 2: PD6 3: PB11	4: PA6 5: PB0 6: PB2 7: PB3	Analog comparator ACMP0, digital output.
ACMP1_O	0: PF2 1: PE3 2: PD7 3: PA12	4: PA14 5: PB9 6: PB10 7: PA5	Analog comparator ACMP1, digital output.
ACMP2_O	0: PD8 1: PE0 2: PE1 3: PI0	4: PI1 5: PI2	Analog comparator ACMP2, digital output.
ACMP3_O	0: PF0 1: PC15 2: PC14 3: PC13	4: PI4 5: PI5	Analog comparator ACMP3, digital output.
ADC0_EXTN	0: PD7		Analog to digital converter ADC0 external reference input negative pin.
ADC0_EXTP	0: PD6		Analog to digital converter ADC0 external reference input positive pin.
ADC1_EXTN	0: PD7		Analog to digital converter ADC1 external reference input negative pin.
ADC1_EXTP	0: PD6		Analog to digital converter ADC1 external reference input positive pin.
BOOT_RX	0: PF1		Bootloader RX.
BOOT_TX	0: PF0		Bootloader TX.

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
EBI_AD08	0: PA15 1: PC1 2: PG8		External Bus Interface (EBI) address and data input / output pin 08.
EBI_AD09	0: PA0 1: PC2 2: PG9		External Bus Interface (EBI) address and data input / output pin 09.
EBI_AD10	0: PA1 1: PC3 2: PG10		External Bus Interface (EBI) address and data input / output pin 10.
EBI_AD11	0: PA2 1: PC4 2: PG11		External Bus Interface (EBI) address and data input / output pin 11.
EBI_AD12	0: PA3 1: PC5 2: PG12		External Bus Interface (EBI) address and data input / output pin 12.
EBI_AD13	0: PA4 1: PA7 2: PG13		External Bus Interface (EBI) address and data input / output pin 13.
EBI_AD14	0: PA5 1: PA8 2: PG14		External Bus Interface (EBI) address and data input / output pin 14.
EBI_AD15	0: PA6 1: PA9 2: PG15		External Bus Interface (EBI) address and data input / output pin 15.
EBI_ALE	0: PF3 1: PB9 2: PC4 3: PB5	4: PC11 5: PC11	External Bus Interface (EBI) Address Latch Enable output.
EBI_ARDY	0: PF2 1: PD13 2: PB15 3: PB4	4: PC13 5: PF10	External Bus Interface (EBI) Hardware Ready Control input.
EBI_BL0	0: PF6 1: PF8 2: PB10 3: PC1	4: PF6 5: PF6	External Bus Interface (EBI) Byte Lane/Enable pin 0.
EBI_BL1	0: PF7 1: PF9 2: PB11 3: PC3	4: PF7 5: PF7	External Bus Interface (EBI) Byte Lane/Enable pin 1.
EBI_CS0	0: PD9 1: PA10 2: PC0 3: PB0	4: PE8	External Bus Interface (EBI) Chip Select output 0.

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
ETH_TSUTMR-TOG	0: PB6 1: PB15 2: PC3 3: PF9		Ethernet IEEE1588 Timer Toggle.
ETM_TCLK	0: PD7 1: PF8 2: PC6 3: PA6	4: PE11 5: PG15	Embedded Trace Module ETM clock .
ETM_TD0	0: PD6 1: PF9 2: PC7 3: PA2	4: PE12 5: PG14	Embedded Trace Module ETM data 0.
ETM_TD1	0: PD3 1: PD13 2: PD3 3: PA3	4: PE13 5: PG13	Embedded Trace Module ETM data 1.
ETM_TD2	0: PD4 1: PB15 2: PD4 3: PA4	4: PE14 5: PG12	Embedded Trace Module ETM data 2.
ETM_TD3	0: PD5 1: PF3 2: PD5 3: PA5	4: PE15 5: PG11	Embedded Trace Module ETM data 3.
GPIO_EM4WU0	0: PA0		Pin can be used to wake the system up from EM4
GPIO_EM4WU1	0: PA6		Pin can be used to wake the system up from EM4
GPIO_EM4WU2	0: PC9		Pin can be used to wake the system up from EM4
GPIO_EM4WU3	0: PF1		Pin can be used to wake the system up from EM4
GPIO_EM4WU4	0: PF2		Pin can be used to wake the system up from EM4
GPIO_EM4WU5	0: PE13		Pin can be used to wake the system up from EM4
GPIO_EM4WU6	0: PC4		Pin can be used to wake the system up from EM4

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
LCD_BEXT	0: PA14		<p>LCD external supply bypass in step down or charge pump mode. If using the LCD in step-down or charge pump mode, a 1 uF (minimum) capacitor between this pin and VSS is required.</p> <p>To reduce supply ripple, a larger capacitor of approximately 1000 times the total LCD segment capacitance may be used.</p> <p>If using the LCD with the internal supply source, this pin may be left unconnected or used as a GPIO.</p>
LCD_COM0	0: PE4		LCD driver common line number 0.
LCD_COM1	0: PE5		LCD driver common line number 1.
LCD_COM2	0: PE6		LCD driver common line number 2.
LCD_COM3	0: PE7		LCD driver common line number 3.
LCD_SEG0	0: PF2		LCD segment line 0.
LCD_SEG1	0: PF3		LCD segment line 1.
LCD_SEG2	0: PF4		LCD segment line 2.
LCD_SEG3	0: PF5		LCD segment line 3.
LCD_SEG4	0: PE8		LCD segment line 4.
LCD_SEG5	0: PE9		LCD segment line 5.
LCD_SEG6	0: PE10		LCD segment line 6.

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
SDIO_DAT7	0: PD9 1: PB4		SDIO Data 7.
SDIO_WP	0: PF9 1: PC5 2: PB15 3: PB9		SDIO Write Protect.
TIM0_CC0	0: PA0 1: PF6 2: PD1 3: PB6	4: PF0 5: PC4 6: PA8 7: PA1	Timer 0 Capture Compare input / output channel 0.
TIM0_CC1	0: PA1 1: PF7 2: PD2 3: PC0	4: PF1 5: PC5 6: PA9 7: PA0	Timer 0 Capture Compare input / output channel 1.
TIM0_CC2	0: PA2 1: PF8 2: PD3 3: PC1	4: PF2 5: PA7 6: PA10 7: PA13	Timer 0 Capture Compare input / output channel 2.
TIM0_CDTI0	0: PA3 1: PC13 2: PF3 3: PC2	4: PB7	Timer 0 Complimentary Dead Time Insertion channel 0.
TIM0_CDTI1	0: PA4 1: PC14 2: PF4 3: PC3	4: PB8	Timer 0 Complimentary Dead Time Insertion channel 1.
TIM0_CDTI2	0: PA5 1: PC15 2: PF5 3: PC4	4: PB11	Timer 0 Complimentary Dead Time Insertion channel 2.
TIM1_CC0	0: PC13 1: PE10 2: PB0 3: PB7	4: PD6 5: PF2 6: PF13 7: PI6	Timer 1 Capture Compare input / output channel 0.
TIM1_CC1	0: PC14 1: PE11 2: PB1 3: PB8	4: PD7 5: PF3 6: PF14 7: PI7	Timer 1 Capture Compare input / output channel 1.
TIM1_CC2	0: PC15 1: PE12 2: PB2 3: PB11	4: PC13 5: PF4 6: PF15 7: PI8	Timer 1 Capture Compare input / output channel 2.
TIM1_CC3	0: PC12 1: PE13 2: PB3 3: PB12	4: PC14 5: PF12 6: PF5 7: PI9	Timer 1 Capture Compare input / output channel 3.
TIM2_CC0	0: PA8 1: PA12 2: PC8 3: PF2	4: PB6 5: PC2 6: PG8 7: PG5	Timer 2 Capture Compare input / output channel 0.

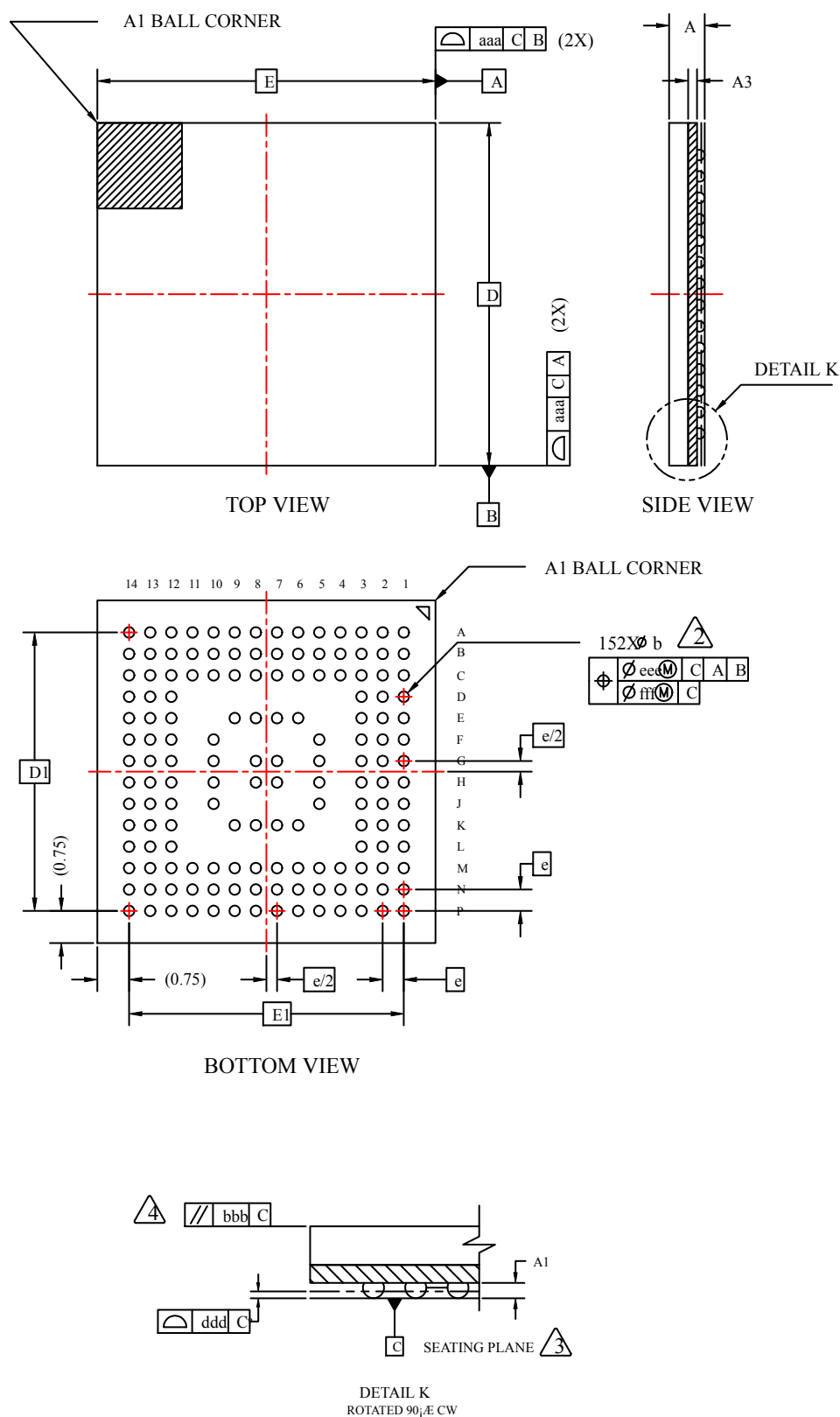


Table 5.28. ADC1 Bus and Pin Mapping

APORT4Y	APORT4X	APORT3Y	APORT3X	APORT2Y	APORT2X	APORT1Y	APORT1X	APORT0Y	APORT0X	Port
BUSDY	BUSDX	BUSCY	BUSCX	BUSBY	BUSBX	BUSAY	BUSAX	BUSADC1Y	BUSADC1X	Bus
	PF15	PF15			PB15	PB15				CH31
PF14			PF14	PB14			PB14			CH30
	PF13	PF13			PB13	PB13				CH29
PF12			PF12	PB12			PB12			CH28
	PF11	PF11			PB11	PB11				CH27
PF10			PF10	PB10			PB10			CH26
	PF9	PF9			PB9	PB9				CH25
PF8			PF8							CH24
	PF7	PF7								CH23
PF6			PF6	PB6			PB6			CH22
	PF5	PF5			PB5	PB5				CH21
PF4			PF4	PB4			PB4			CH20
	PF3	PF3			PB3	PB3				CH19
PF2			PF2	PB2			PB2			CH18
	PF1	PF1			PB1	PB1				CH17
PF0			PF0	PB0			PB0			CH16
	PE15	PE15			PA15	PA15				CH15
PE14			PE14	PA14			PA14			CH14
	PE13	PE13			PA13	PA13				CH13
PE12			PE12	PA12			PA12			CH12
	PE11	PE11			PA11	PA11				CH11
PE10			PE10	PA10			PA10			CH10
	PE9	PE9			PA9	PA9				CH9
PE8			PE8	PA8			PA8			CH8
	PE7	PE7			PA7	PA7		PH7	PH7	CH7
PE6			PE6	PA6			PA6	PH6	PH6	CH6
	PE5	PE5			PA5	PA5		PH5	PH5	CH5
PE4			PE4	PA4			PA4	PH4	PH4	CH4
					PA3	PA3		PH3	PH3	CH3
				PA2			PA2	PH2	PH2	CH2
	PE1	PE1			PA1	PA1		PH1	PH1	CH1
PE0			PE0	PA0			PA0	PH0	PH0	CH0

## 7. BGA152 Package Specifications

## 7.1 BGA152 Package Dimensions



**Figure 7.1. BGA152 Package Drawing**

**Table 8.2. BGA120 PCB Land Pattern Dimensions**

Dimension	Min	Nom	Max
X		0.20	
C1		6.00	
C2		6.00	
E1		0.5	
E2		0.5	

**Note:**

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing is per the ANSI Y14.5M-1994 specification.
3. This Land Pattern Design is based on the IPC-7351 guidelines.
4. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60  $\mu\text{m}$  minimum, all the way around the pad.
5. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
6. The stencil thickness should be 0.125 mm (5 mils).
7. The ratio of stencil aperture to land pad size should be 1:1.
8. A No-Clean, Type-3 solder paste is recommended.
9. The recommended card reflow profile is per the JEDEC/IPC J-STD-020C specification for Small Body Components.

## 9. BGA112 Package Specifications

### 9.1 BGA112 Package Dimensions

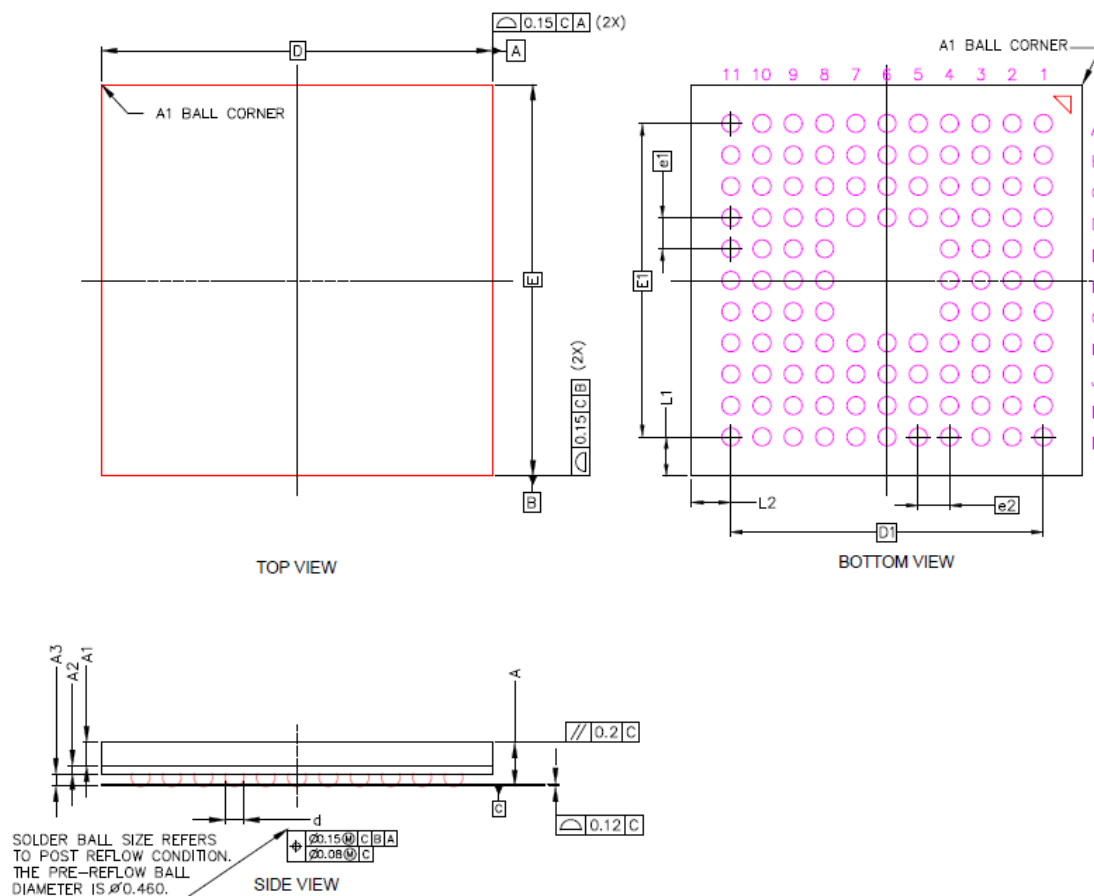


Figure 9.1. BGA112 Package Drawing

**Table 9.1. BGA112 Package Dimensions**

Dimension	Min	Typ	Max
A	-	-	1.30
A1	0.55	0.60	0.65
A2	0.21 BSC		
A3	0.30	0.35	0.40
d	0.43	0.48	0.53
D	10.00 BSC		
D1	8.00 BSC		
E	10.00 BSC		
E1	8.00 BSC		
e1	0.80 BSC		
e2	0.80 BSC		
L1	1.00 REF		
L2	1.00 REF		

**Note:**

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.